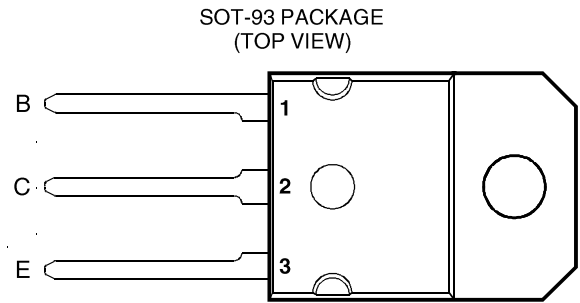


- 50 W at 25°C Case Temperature
- 10 A Continuous Collector Current
- 15 A Peak Collector Current
- Maximum $V_{CE(sat)}$ of 2.8 V at $I_C = 6.5$ A
- $I_{CEX(sus)}$ 7 A at rated $V_{(BR)CEO}$



Pin 2 is in electrical contact with the mounting base.

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

| RATING | | SYMBOL | VALUE | UNIT |
|--|--------|-----------|-------------|------|
| Collector-base voltage ($I_E = 0$) | TIP160 | V_{CBO} | 320 | V |
| | TIP161 | | 350 | |
| | TIP162 | | 380 | |
| Collector-emitter voltage ($I_B = 0$) | TIP160 | V_{CEO} | 320 | V |
| | TIP161 | | 350 | |
| | TIP162 | | 380 | |
| Emitter-base voltage | | V_{EBO} | 5 | V |
| Continuous collector current | | I_C | 10 | A |
| Peak collector current (see Note 1) | | I_{CM} | 15 | A |
| Peak commutating anti-parallel diode current ($I_B = 0$) (see Note 2) | | I_{EM} | 10 | A |
| Continuous base current | | I_B | 1 | A |
| Continuous device dissipation at (or below) 100°C case temperature (see Note 3) | | P_{tot} | 50 | W |
| Continuous device dissipation at (or below) 25°C free air temperature (see Note 4) | | P_{tot} | 3 | W |
| Operating junction temperature range | | T_j | -65 to +150 | °C |
| Storage temperature range | | T_{stg} | -65 to +150 | °C |
| Lead temperature 3.2 mm from case for 10 seconds | | T_L | 260 | °C |

- NOTES: 1. This value applies for $t_p \leq 10$ ms, duty cycle $\leq 10\%$.
 2. This value applies to the total collector-terminal current when the collector is at negative potential with respect to the emitter.
 3. Derate linearly to 150°C case temperature at the rate of 0.4 W/°C.
 4. Derate linearly to 150°C free air temperature at the rate of 24 mW/°C.

TIP160, TIP161, TIP162

NPN SILICON POWER DARLINGTONS

electrical characteristics at 25°C case temperature

| PARAMETER | | TEST CONDITIONS | | | MIN | TYP | MAX | UNIT |
|----------------|--------------------------------------|---------------------------|----------------------|---------------------|-----|-----|-----|------|
| I_{CEO} | Collector-emitter cut-off current | $V_{CE} = 320\text{ V}$ | $I_B = 0$ | TIP160 | | | | |
| | | $V_{CE} = 350\text{ V}$ | $I_B = 0$ | TIP161 | | | 1 | mA |
| | | $V_{CE} = 380\text{ V}$ | $I_B = 0$ | TIP162 | | | | |
| $I_{CEX(sus)}$ | Collector-emitter sustaining current | $V_{CLAMP} = V_{(BR)CEO}$ | | | 7 | | | A |
| I_{EBO} | Emitter cut-off current | $V_{EB} = 5\text{ V}$ | $I_C = 0$ | | | 100 | mA | |
| h_{FE} | Forward current transfer ratio | $V_{CE} = 2.2\text{ V}$ | $I_C = 4\text{ A}$ | (see Notes 5 and 6) | 200 | | | |
| $V_{CE(sat)}$ | Collector-emitter saturation voltage | $I_B = 0.1\text{ A}$ | $I_C = 6.5\text{ A}$ | (see Notes 5 and 6) | | | 2.8 | V |
| | | $I_B = 1\text{ A}$ | $I_C = 10\text{ A}$ | (see Notes 5 and 6) | | | 2.9 | |
| $V_{BE(sat)}$ | Base-emitter saturation voltage | $I_B = 0.1\text{ A}$ | $I_C = 6.5\text{ A}$ | (see Notes 5 and 6) | | | 2.2 | V |
| V_{EC} | Parallel diode forward voltage | $I_E = 10\text{ A}$ | $I_B = 0$ | (see Notes 5 and 6) | | | 3.5 | V |

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

| PARAMETER | | MIN | TYP | MAX | UNIT |
|-----------------|---|-----|-----|------|------|
| $R_{\theta JC}$ | Junction to case thermal resistance | | | 1 | °C/W |
| $R_{\theta JA}$ | Junction to free air thermal resistance | | | 41.7 | °C/W |
| $C_{\theta C}$ | Thermal capacitance of case | | 1.4 | | J/°C |

resistive-load-switching characteristics at 25°C case temperature

| PARAMETER | | TEST CONDITIONS † | | | MIN | TYP | MAX | UNIT |
|-----------|--------------|----------------------|-----------------------------|-------------------------------|-----------------------------|-------------------------|-----|---------------|
| t_d | Delay time | | | | | 40 | | ns |
| t_r | Rise time | $I_C = 6.5\text{ A}$ | $I_{B(on)} = 100\text{ mA}$ | $I_{B(off)} = -100\text{ mA}$ | | 1.5 | | μs |
| t_s | Storage time | | | | | 2.2 | | μs |
| t_f | Fall time | | | | | 2.6 | | μs |
| | | | | | $V_{BE(off)} = -5\text{ V}$ | $R_L = 5\text{ }\Omega$ | | |

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

PARAMETER MEASUREMENT INFORMATION

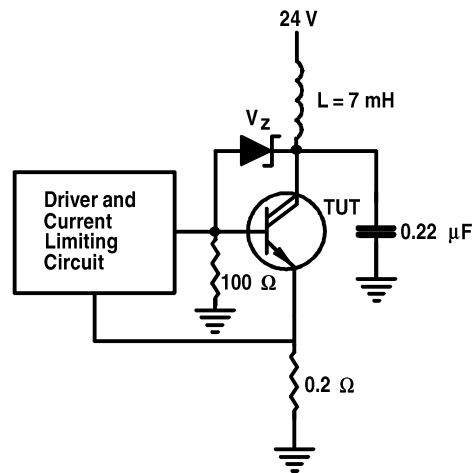


Figure 1. Functional Test Circuit

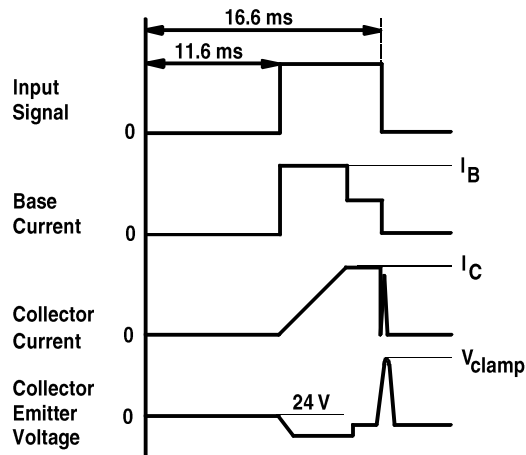
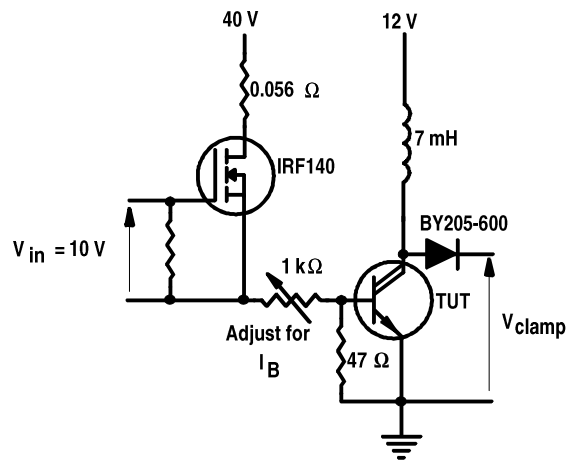


Figure 2. Functional Test Waveforms



TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
 VS
 COLLECTOR CURRENT

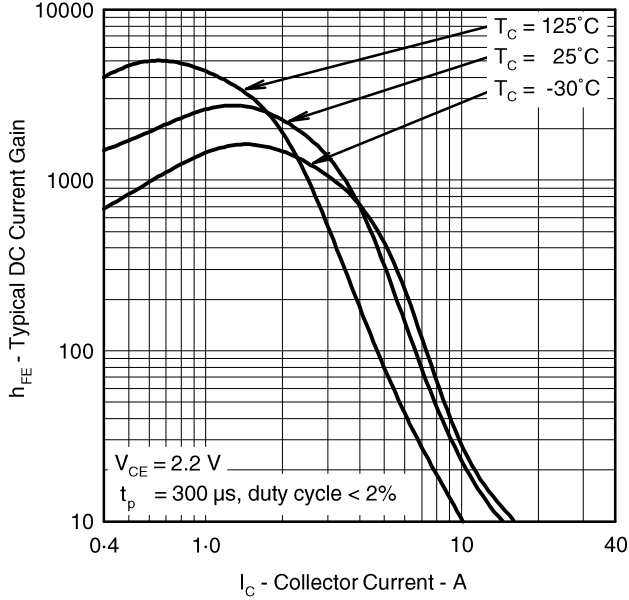


Figure 4.

COLLECTOR-EMITTER SATURATION VOLTAGE
 VS
 COLLECTOR CURRENT

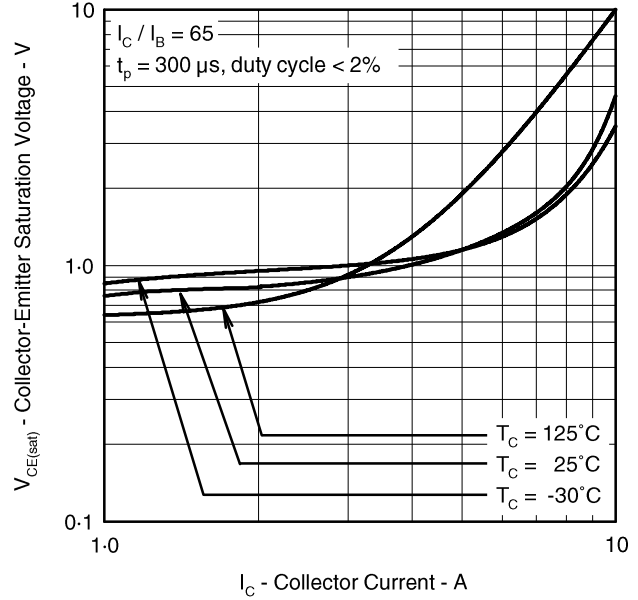


Figure 5.

COLLECTOR-EMITTER SATURATION VOLTAGE
 VS
 COLLECTOR CURRENT

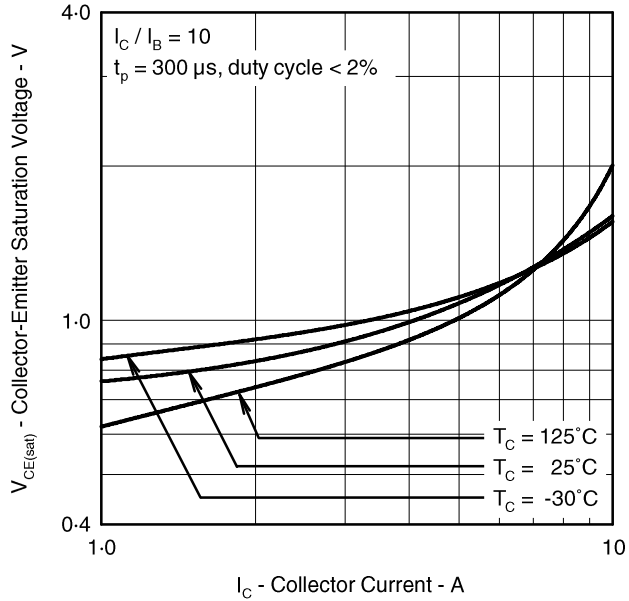


Figure 6.

BASE-EMITTER SATURATION VOLTAGE
 VS
 COLLECTOR CURRENT

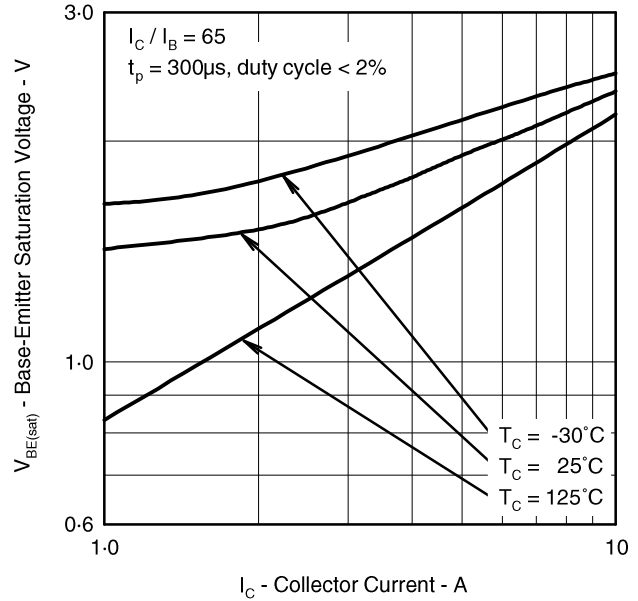


Figure 7.

MAXIMUM SAFE OPERATING REGIONS

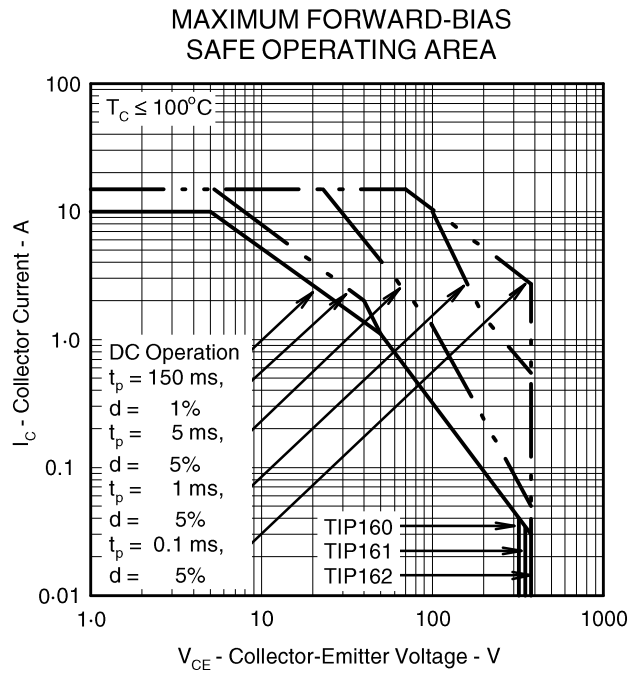


Figure 8.

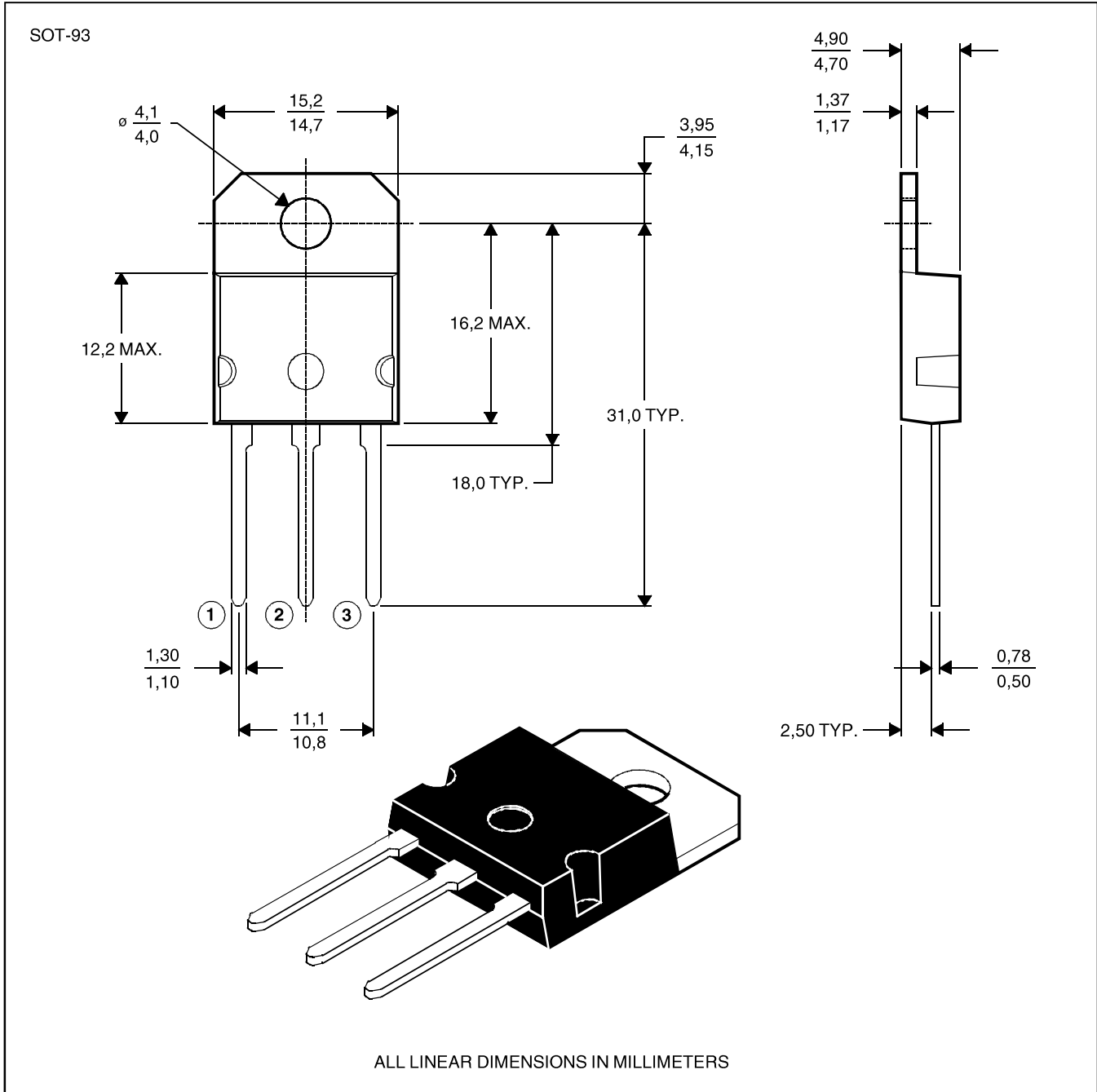
TIP160, TIP161, TIP162 NPN SILICON POWER DARLINGTONS

MECHANICAL DATA

SOT-93

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTE A: The centre pin is in electrical contact with the mounting tab.